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Probes for Diagnosing EMC Problems

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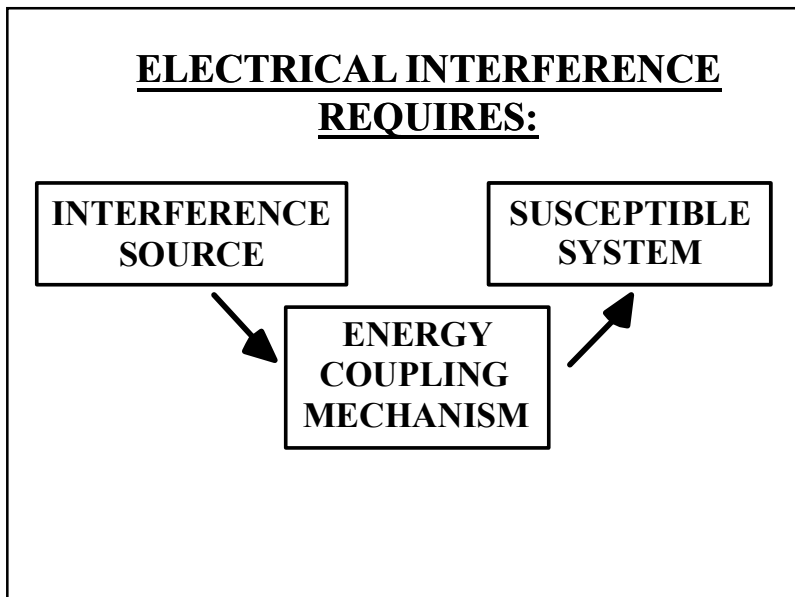
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PRESENTATION OUTLINE

- Energy Coupling Mechanisms
- Key Probe Characteristics
- Voltage Probes
- Clamp-on Current Probes
- Magnetic-Field Probes
- Electric-Field Probes

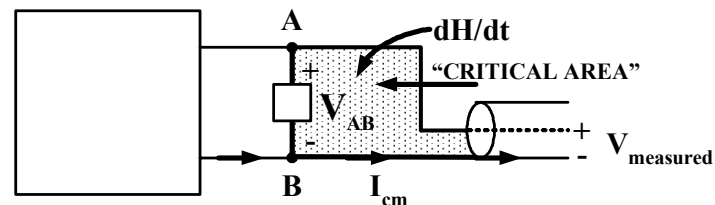


Coupling Mechanism	Quantity Measured	Measuring Process
Conducted	Voltage Difference (V)	Resistive Divider + Amplifier
	Current (I)	Resistive Shunt ($I = V/R$) Magnetic Coupling (XFMR)
Near Field	Magnetic Field (H)	Magnetic Coupling $V = M dI/dt \propto dH/dt$
	Electric Field (E)	Displacement Current $I = C dV/dt \propto dE/dt$
Far Field	EM Wave	"Antenna" $V_{OUT} = A F \times E$

**SOME KEY PROBE CHARACTERISTICS
FOR DIAGNOSTIC MEASUREMENTS**

- Bandwidth
- Sensitivity
- Impedance Loading
- Field Perturbation
- Spatial Resolution
- Impedance Balance
- Repeatable Positioning
- Ruggedness
- Cost

**VOLTAGE PROBES
MAJOR SOURCES OF MEASUREMENT ERROR**

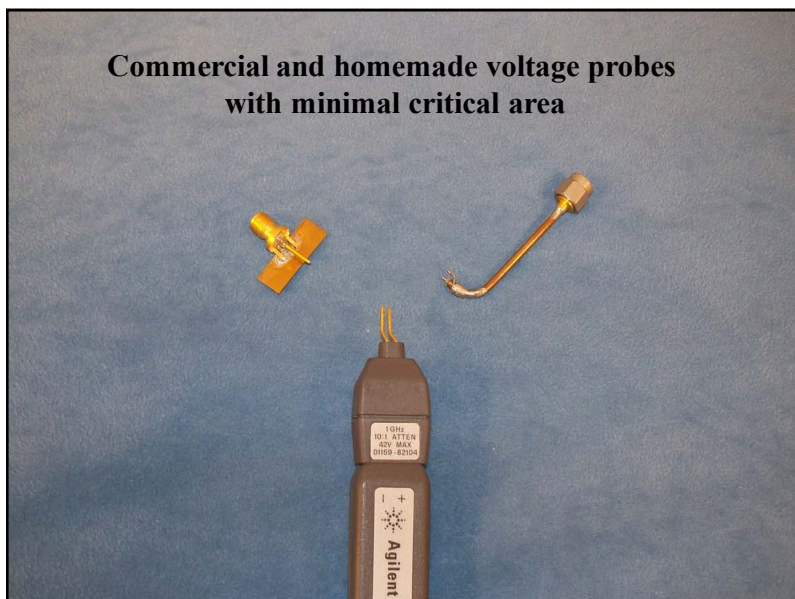


$$|V_{\text{measured}}| = V_{AB} \pm \omega_1 M I_{CM} \pm \omega_2 \mu \int H \cdot ds$$

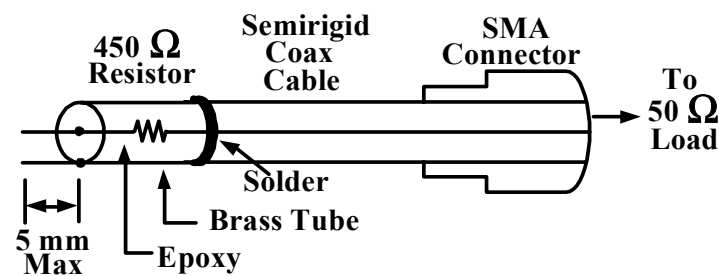
Must minimize the "CRITICAL AREA".

Might reduce I_{CM} with ferrite beads around coaxial cable.

Commercial and homemade voltage probes with minimal critical area

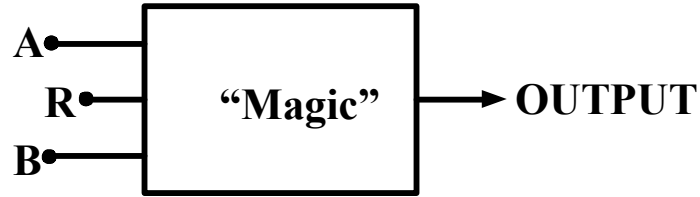


**A SIMPLE, PASSIVE, UNBALANCED
X10 VOLTAGE PROBE DESIGN**



- Inexpensive to buy or build
- Only 500 Ω input impedance
- Flat frequency response to several GHz
- Minimal sensitivity to ESD

ACTIVE, BALANCED, HIGH IMPEDANCE DIFFERENTIAL VOLTAGE PROBE



R = "Reference Node" (= Ground ???)

Some differential probe systems can measure:

$$V_{AB}, V_{AR}, V_{BR}, \text{ \& } (V_{AR} + V_{BR})/2$$

GHz bandwidth, Expensive, ESD sensitive

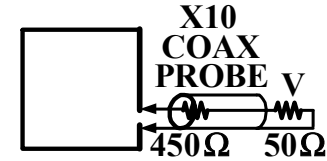
MEASURING VOLTAGE DIFFERENCES ACROSS SEAMS AND ARPETURES

Estimate of E-Field at distance R:

$$E \approx \frac{10V}{L} = \frac{10V}{\pi R}$$

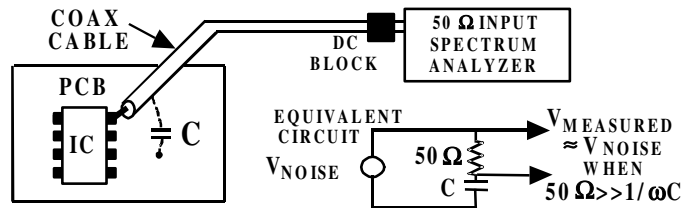
L = semicircular arc

Assumes $R \ll \lambda$



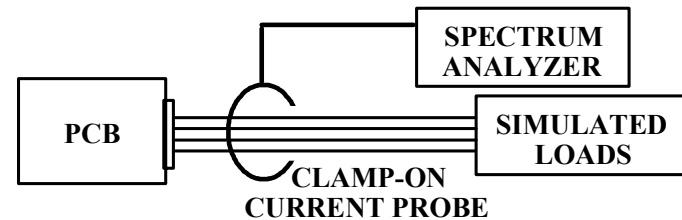
A relative measurement of the voltage differences across a variety of seams might identify the location of dominant energy leakage.

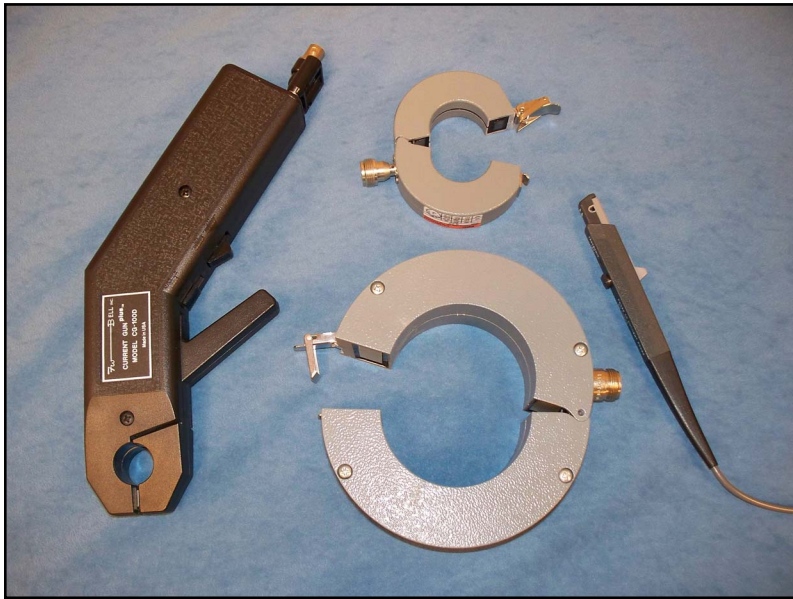
MEASURE APPROXIMATE RF VOLTAGE DIFFERENCE USING ONE CONDUCTIVE CONTACT AND ONE CAPACITIVE CONTACT



Find circuit nodes with unexpected RF activity

MEASURING I_{CM} ON CABLES USING A CLAMP-ON CURRENT PROBE





$I_{CM} > 5 \mu A$ CAN EXCEED RADIATION LIMIT

E (V/m) at distance r (m) from a $\lambda/2$ dipole:

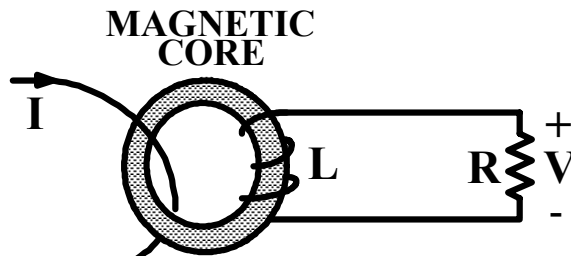
$$E = \frac{60I}{r}, \text{ I = current (A) at center of dipole}$$

FCC class B radiated emission limit requires:

$$E < 40 \text{ dB}\mu\text{V/m} = 100 \mu\text{V/m}, 30\text{-}88 \text{ MHz}, r = 3 \text{ m}$$

$$I < \frac{rE}{60} = \frac{(3 \text{ m})(100 \mu\text{V/m})}{60 \Omega} = 5 \mu\text{A}$$

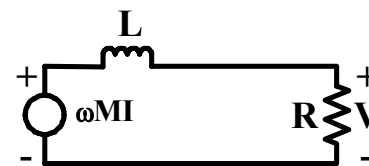
CLAMP-ON CURRENT PROBE



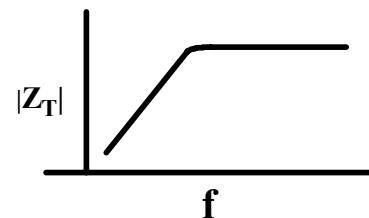
$$|I| = |V/Z_T|$$

I = the "net" or CM Current on the cable

CLAMP-ON CURRENT PROBE SIMPLIFIED EQUIVALENT CIRCUIT OF OUTPUT



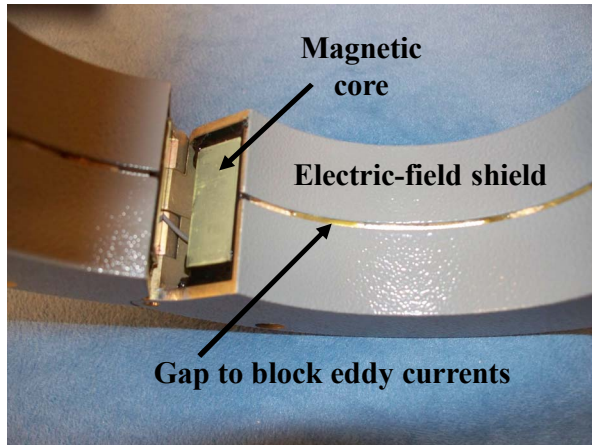
$$|V| = \frac{\omega M R I}{\sqrt{R^2 + (\omega L)^2}} = I |Z_T|$$



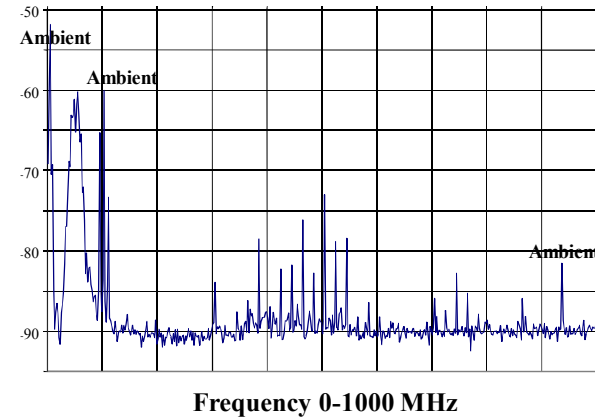
For $\omega L \ll R, |Z_T| = \omega M$

For $\omega L \gg R, |Z_T| = MR/L$

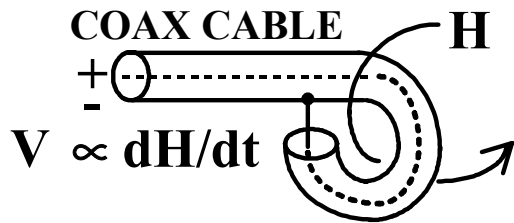
**CLAMP-ON CURRENT PROBES
REQUIRE ELECTRIC-FIELD SHIELDING**



**Typical Cable Common-Mode Current
(measured in terms of the power received at spectrum analyzer, dBm)**



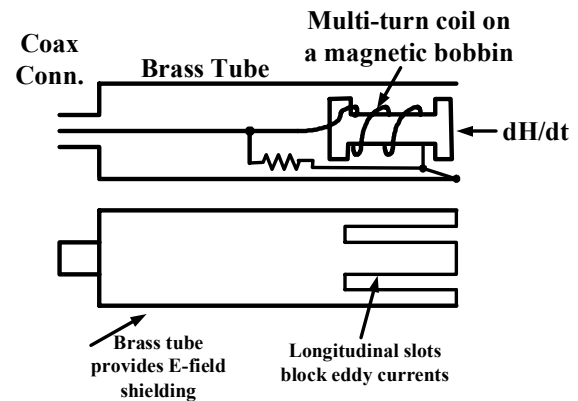
**MAGNETIC-FIELD PROBES FOR
MHz TO GHz FREQUENCIES**



Electric-field shielding is provided by the coax outer conductor.

Usually, the loop diameter is reduced for higher frequencies to improve spatial resolution.

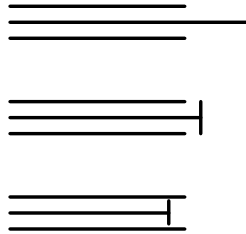
**MAGNETIC-FIELD PROBE DESIGN FOR A PEAK
RESPONSE IN THE 1 kHz TO 10 MHz RANGE**



Center frequency and bandwidth are determined by number of turns, wire size, magnetic core material, etc.

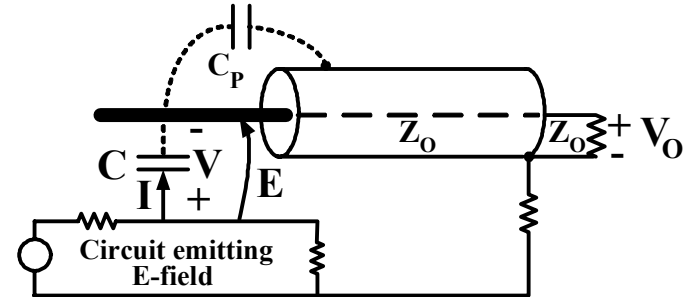
VARIOUS ELECTRIC-FIELD PROBE DESIGNS

Coaxial cable



Reduced sensitivity
but increased
spatial resolution
and directivity

ELECTRIC-FIELD PROBE MEASURES DISPLACEMENT CURRENT



$$V \propto E; \quad |I| = |\omega CV| \propto E$$

$$|V_0| = \left| \frac{\omega CZ_0 V}{1 + j\omega C_p Z_0} \right| \propto E$$

